

Surface Mount Phase Detector

50Ω High Output 1 to 100 MHz

SYPD-1+



Generic photo used for illustration purposes only

CASE STYLE: TTT167

Maximum Ratings

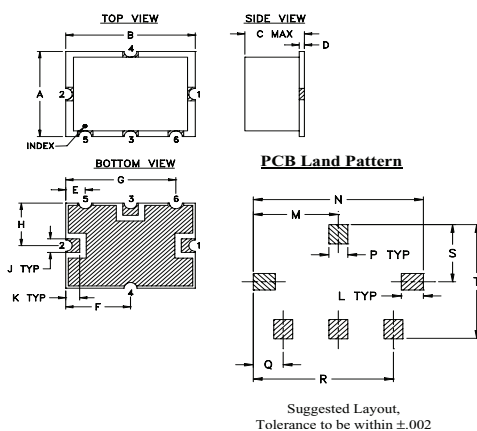
Operating Temperature	-40°C to 85°C
Storage Temperature	-55°C to 100°C
Input Power	50mW
Peak IF current	20mA

Permanent damage may occur if any of these limits are exceeded.

Pin Connections

RF REF (RF2)	2
RF IN (RF1)	1
DC OUT (I)	3
GROUND	4,5,6

Outline Drawing

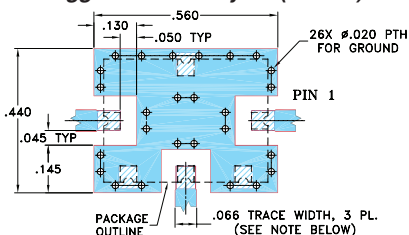


Outline Dimensions (inch/mm)

A	B	C	D	E	F	G	H	J	K
.38	.50	.23	.020	.075	.250	.425	.187	.050	.050
9.65	12.70	5.84	0.51	1.91	6.35	10.80	4.75	1.27	1.27

L	M	N	P	Q	R	S	T	wt.
.070	.270	.540	.060	.095	.445	.208	.415	grams
1.78	6.86	13.72	1.52	2.41	11.30	5.28	10.54	0.8

Demo Board MCL P/N: TB-12 Suggested PCB Layout (PL-079)



NOTE:

- TRACE WIDTH IS SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS .030" ± .002"; COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
- THE USE OF SOLDER MASK OVER THE GROUND AREA UNDER THE UNIT AS SHOWN IS RECOMMENDED TO PREVENT POTENTIAL SHORTING. IF USER CHOOSES TO EXPOSE METAL UNDER THE ENTIRE UNIT GROUND PAD FOR IMPROVED GROUNDING, IT IS RECOMMENDED A SOLDER MASK DAM BE APPLIED AROUND EACH GROUND PAD TO ENSURE FILLET AND CONNECTION AT GROUND PADS.
- BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

- DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER), SEE NOTE 2.
- DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

Notes

- Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
- Electrical specifications and performance data contained in this specification document are based on Mini-Circuits' applicable established test performance criteria and measurement instructions.
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Features

- wideband, 1 to 100 MHz
- low DC offset, 0.2 mV typ.
- high DC output, 1000 mV typ.
- high isolation, 40 dB min.

Applications

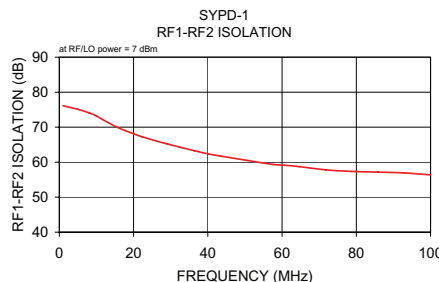
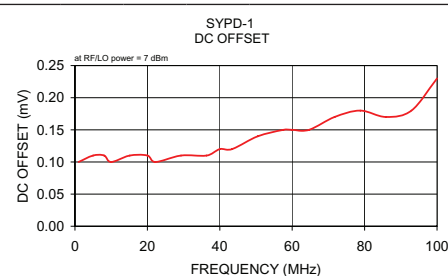
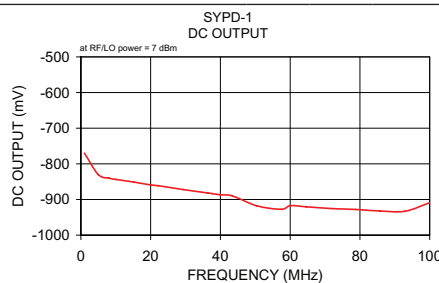
- monitoring circuits
- leveling circuits
- PLL

Electrical Specifications

FREQUENCY (MHz)	POWER IN	SCALE FACTOR	IMPEDANCE (ohms)	ISOLATION (dB)	OUTPUT POLARITY	DC OUTPUT (mV)		FIGURE OF MERIT	
						Max. Typ.	Offset Typ. Max.		
RF1	RF1								
RF2	RF2 (dBm)	mV/deg.							
1-100	DC-50	7	8	500	40	neg.	1000 700	0.2 1	143

Typical Performance Data

Frequency (MHz)	DC Output mV		DC Offset mV		RF1-RF2 Isolation (dB)
	\bar{X}	σ	\bar{X}	σ	
1.00	-769.98	14.85	0.10	0.16	76.12
5.00	-830.34	8.90	0.11	0.18	75.09
8.07	-840.24	14.44	0.11	0.18	74.07
10.00	-843.71	14.61	0.10	0.18	73.19
15.14	-851.12	17.01	0.11	0.19	70.19
20.00	-859.20	18.91	0.11	0.19	68.10
22.21	-861.26	20.52	0.10	0.20	67.28
29.29	-872.02	22.55	0.11	0.21	65.14
36.36	-881.57	24.77	0.11	0.22	63.29
40.00	-886.86	25.39	0.12	0.23	62.38
43.43	-889.93	26.41	0.12	0.23	61.76
50.50	-917.82	25.99	0.14	0.25	60.51
57.57	-927.50	28.69	0.15	0.27	59.35
60.00	-917.14	33.08	0.15	0.26	59.18
64.64	-920.62	38.60	0.15	0.27	58.73
71.71	-925.22	45.18	0.17	0.31	57.82
78.79	-928.03	51.83	0.18	0.31	57.35
85.86	-932.34	57.31	0.17	0.31	57.15
92.93	-932.98	60.65	0.18	0.38	56.93
100.00	-909.17	74.27	0.23	0.43	56.36



electrical schematic

